

20V N-Channel Enhancement Mode Power MOSFET

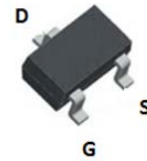
DESCRIPTION :

- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- $R_{DS(ON),typ.} = 135m\Omega @ V_{GS}=4.5V$
- RoHS compliant

V_{DS}	20V
I_D	0.9A
$R_{DS(ON),Typ.} @ V_{GS}=4.5V$	135m Ω

TYPICAL APPLICATIONS :

- Power Management
- Load Switch



SOT-23

MAXIMUM RATINGS (at $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	20	V
Gate-Source Voltage		V_{GSS}	± 10	V
Continuous Drain Current ⁽¹⁾	$T_A=25^\circ\text{C}$ $T_A=100^\circ\text{C}$	I_D	0.9 0.6	A
Pulsed Drain Current		I_{DM}	3.6	A
Power dissipation		P_D	0.23	W
Operating & Storage temperature Range		T_J, T_{STG}	-55~+150	$^\circ\text{C}$

Notes : 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance,	Junction-to-Ambient	$R_{\theta JA}$	543	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS (at $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage $V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$	$V_{(BR)DSS}$	20			V
Zero Gate Voltage Drain Current $V_{DS} = 20\text{V}$, $V_{GS} = 0\text{V}$	I_{DSS}			1	μA
Gate-Source Leakage Current $V_{GS} = \pm 10\text{V}$, $V_{DS} = 0\text{V}$	I_{GSS}			± 10	μA
Gate-Source threshold voltage $V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	$V_{GS(th)}$	0.4	0.7	1.0	V
Drain-Source On-State Resistance $V_{GS} = 4.5\text{V}$, $I_D = 0.5\text{A}$ $V_{GS} = 2.5\text{V}$, $I_D = 0.4\text{A}$	$R_{DS(on)}$		135 195	240 280	m Ω
Input capacitance $f = 1\text{MHz}$, $V_{DS} = 10\text{V}$, $V_{GS} = 0\text{V}$	C_{iss}		60		pF
Output capacitance $f = 1\text{MHz}$, $V_{DS} = 10\text{V}$, $V_{GS} = 0\text{V}$	C_{oss}		22		pF
Reverse transfer capacitance $f = 1\text{MHz}$, $V_{DS} = 10\text{V}$, $V_{GS} = 0\text{V}$	C_{rss}		12		pF
Total Gate Charge $V_{DS} = 10\text{V}$, $I_D = 0.9\text{A}$, $V_{GS} = 4.5\text{V}$	Q_G		1		nC
Gate to Source Charge $V_{DS} = 10\text{V}$, $I_D = 0.9\text{A}$, $V_{GS} = 4.5\text{V}$	Q_{GS}		0.28		nC
Gate to Drain Charge $V_{DS} = 10\text{V}$, $I_D = 0.9\text{A}$, $V_{GS} = 4.5\text{V}$	Q_{GD}		0.22		nC
Turn-on delay time $V_{DS} = 10\text{V}$, $V_{GS} = 4.5\text{V}$, $I_D = 0.5\text{A}$, $R_{GEN} = 10\Omega$	$t_{d(ON)}$		2		ns
Turn-on Rise time $V_{DS} = 10\text{V}$, $V_{GS} = 4.5\text{V}$, $I_D = 0.5\text{A}$, $R_{GEN} = 10\Omega$	t_r		19		ns
Turn-off delay time $V_{DS} = 10\text{V}$, $V_{GS} = 4.5\text{V}$, $I_D = 0.5\text{A}$, $R_{GEN} = 10\Omega$	$t_{d(OFF)}$		10		ns
Turn-off Fall time $V_{DS} = 10\text{V}$, $V_{GS} = 4.5\text{V}$, $I_D = 0.5\text{A}$, $R_{GEN} = 10\Omega$	t_f		23		ns

Body Diode

Drain to Source Diode Forward Current	I_S			0.9	A
Drain to Source Diode Forward Voltage $V_{GS} = 0\text{V}$, $I_{SD} = 0.9\text{A}$	V_{SD}			1.2	V

Typical Characteristics

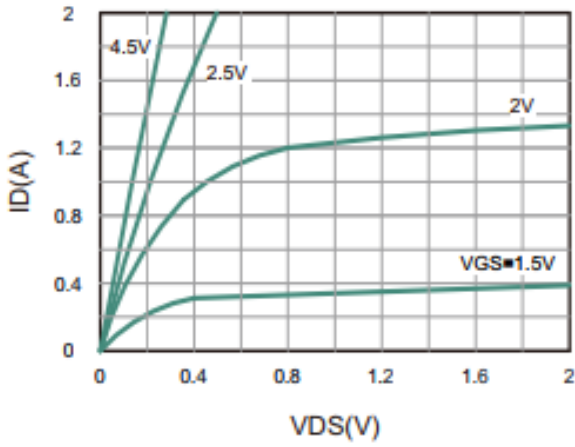


Figure 1. Output Characteristics

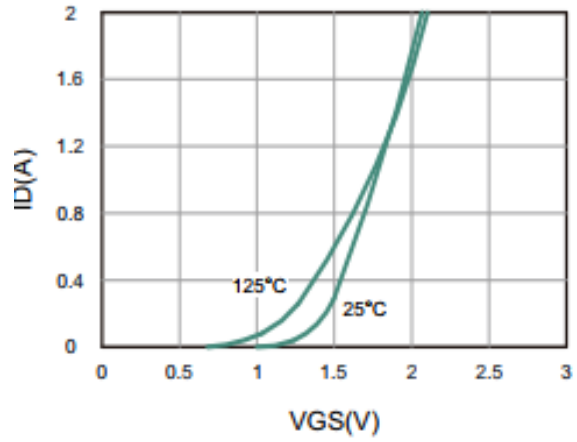


Figure 2. Transfer Characteristics

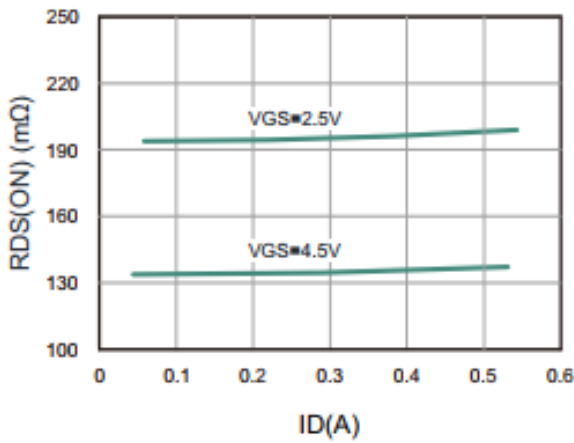


Figure 3. On-resistance vs. Drain Current

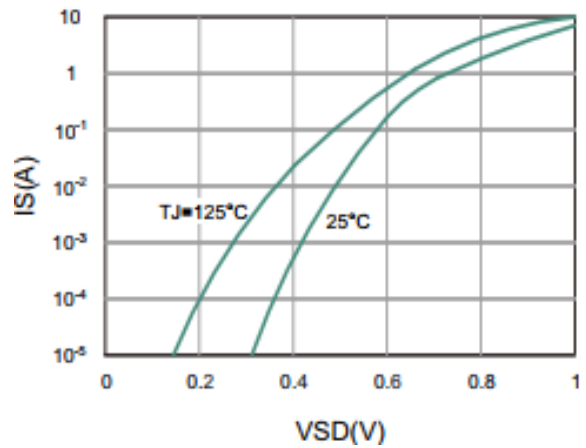


Figure 4. Body Diode Characteristics

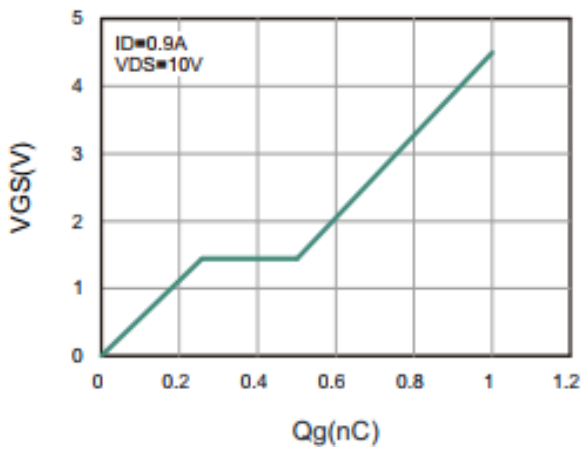


Figure 5. Gate Charge Characteristics

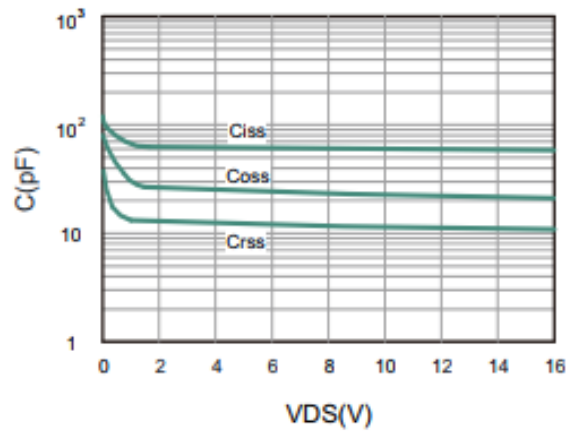


Figure 6. Capacitance Characteristics

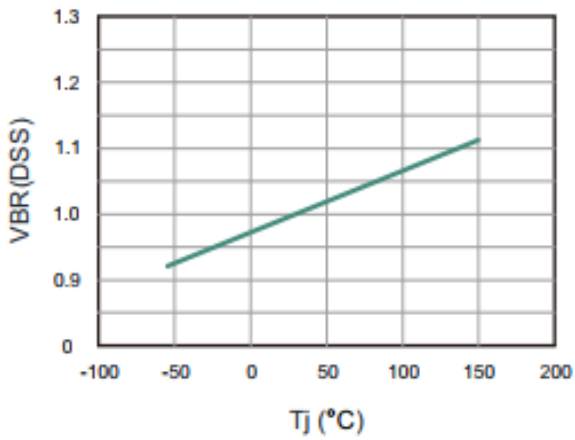


Figure 7. Normalized Breakdown Voltage vs. Junction Temperature

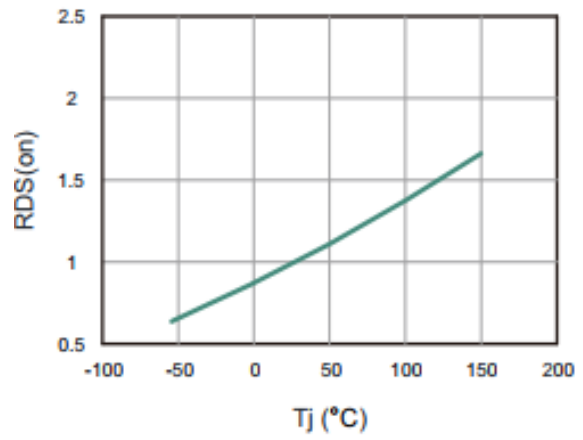


Figure 8. Normalized on Resistance vs. Junction Temperature

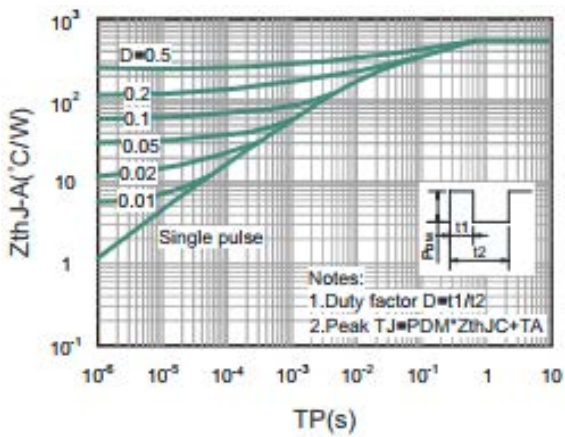


Figure 9. Maximum Effective Transient Thermal Impedance, Junction to Ambient

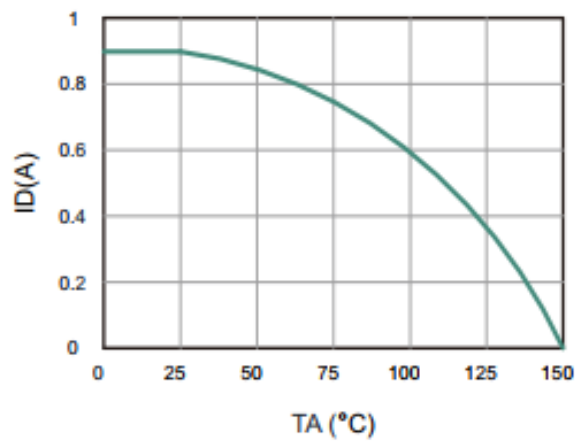


Figure 10. Maximum Continuous Drain Current vs. Ambient Temperature

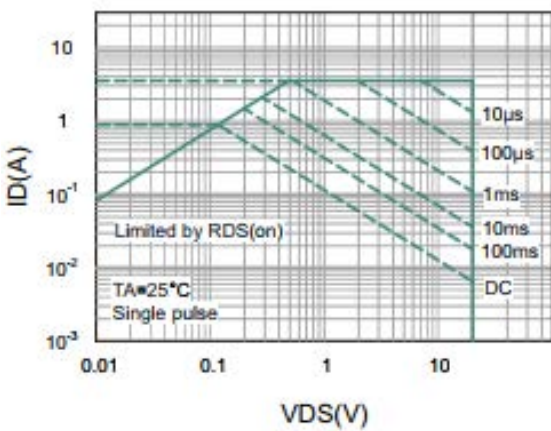
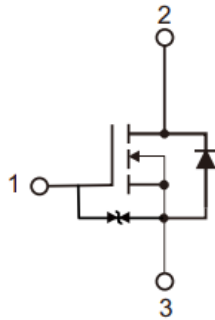
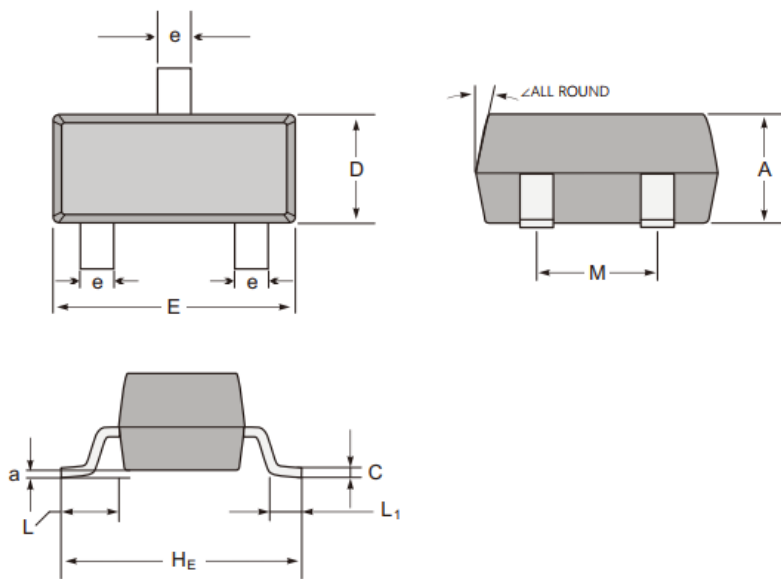


Figure 11. Maximum Safe Operating Area

• Circuit diagram



• SOT-23 Package outlines : Dimensions in (mm)



SOT-23 mechanical data

UNIT	A	C	D	E	HE	e	M	L	L1	a	∠	
mm	max	1.1	0.20	1.4	3.0	2.6	0.6	1.95	0.55 (ref)	0.36 (ref)	0.15	12°
	min	0.9	0.08	1.2	2.8	2.2	0.35	1.7		0.0		
mil	max	43	7.9	55	118	102	24	77	22 (ref)	14 (ref)	6	
	min	35	3.1	47	110	87	13	67		0.0		

Notice

MOSPEC reserves the rights to make changes of the content herein the document anytime without notification. MOSPEC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies. Please refer to MOSPEC website for the last document.

MOSPEC disclaims any and all liability arising out of the application or use of any product including damages incidentally and consequentially incurred.

Application shown on the herein document are examples of standard use and operation. Customers are responsible for comprehending suitable use in particular applications. MOSPEC makes no representation or warranty that such application will be suitable for the specified use without further testing or modification.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by MOSPEC for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of MOSPEC or others.

These MOSPEC products are intended for usage in general electronic equipment. Please make sure to consult with MOSPEC before you use these MOSPEC products in equipment which require specialized quality and/or reliability, and in equipment which could have major impact to the welfare of human life (atomic energy control, aeronautics , traffic control, combustion control, safety devices etc.)